

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	IPD650P06NM	**Issued**	08. April 2022
MA#	MA005710359		
Package	PG-TO252-3-313	**Weight***	318.55 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.545	0.80	0.80	7988	7988
leadframe	inorganic material	phosphorus	7723-14-0	0.044	0.01		139	
	non noble metal	iron	7439-89-6	0.147	0.05		462	
	non noble metal	copper	7440-50-8	147.096	46.17	46.23	461774	462375
wire	non noble metal	aluminium	7429-90-5	1.453	0.46	0.46	4562	4562
encapsulation	inorganic material	zincoxide	1314-13-2	1.406	0.44		4414	
	miscellaneous	miscellaneous	-	7.030	2.21		22070	
	plastics	epoxy resin	-	21.091	6.62		66211	
	inorganic material	silicondioxide	60676-86-0	111.080	34.87	44.14	348709	441404
leadfinish	non noble metal	tin	7440-31-5	3.740	1.17	1.17	11741	11741
plating	inorganic material	phosphorus	7723-14-0	0.003			11	
	non noble metal	nickel	7440-02-0	1.421	0.45	0.45	4459	4470
solder	non noble metal	tin	7440-31-5	0.046	0.01		144	
	noble metal	silver	7440-22-4	0.057	0.02		179	
	non noble metal	lead	7439-92-1	2.184	0.69	0.72	6856	7179
heatspreader	inorganic material	phosphorus	7723-14-0	0.006			18	
	non noble metal	iron	7439-89-6	0.019	0.01		60	
	non noble metal	copper	7440-50-8	19.177	6.02	6.03	60203	60281
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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